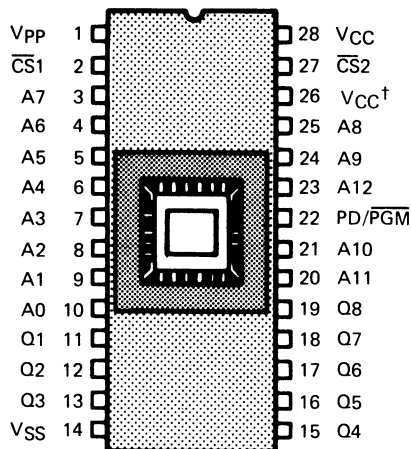


- Organization . . . 8K X 8
- Single +5 V Power Supply
- Pin Compatible with Existing ROMs and EPROMs (8K, 16K, 32K, and 64K)
- All Inputs/Outputs Fully TTL Compatible
- Static Operation (No Clocks, No Refresh)
- Max Access/Min Cycle Time . . . 450 ns
- 8-Bit Output for Use in Microprocessor-Based Systems
- N-Channel Silicon-Gate Technology
- 3-State Output Buffers
- Guaranteed DC Noise Immunity with Standard TTL Loads
- No Pull-Up Resistors Required
- Low Power Dissipation:

Active . . . 400 mW Typical  
Standby . . . 75 mW Typical

**TMS 2564  
28-PIN CERAMIC  
DUAL-IN-LINE PACKAGE  
(TOP VIEW)**



†V<sub>CC</sub> may be connected to pin 26 for 24-pin ROM compatibility.

PIN NOMENCLATURE	
A(N)	Address inputs
$\overline{CS}(N)$	Chip Selects
PD/PGM	Power Down/Program
Q(N)	Input/Output
V <sub>CC</sub>	+5 V Power Supply
V <sub>pp</sub>	+25 V Power Supply
V <sub>SS</sub>	0 V Ground

**description**

The TMS 2564 is a 65,536-bit, ultraviolet-light-erasable, electrically programmable read-only memory. This device is fabricated using N-channel silicon-gate technology for high-speed and simple interface with MOS and bipolar circuits. All inputs (including program data inputs) can be driven by Series 74 TTL circuits without the use of external pull-up resistors, and each output can drive one Series 74 TTL circuit without external resistors. The data outputs are three-state for connecting multiple devices to a common bus. The TMS 2564 is offered in a dual-in-line ceramic package (JL or JDL suffix)\* rated for operation from 0°C to 70°C.

Since this EPROM operates from a single +5 V supply (in the read mode), it is ideal for use in microprocessor systems. One other supply (+25 V) is needed for programming. Programming requires a single TTL level pulse per location. For programming outside of the system, existing EPROM programmers can be used. Locations may be programmed singly, in blocks, or at random.

The TMS 2564 is compatible with other 5-volt ROMs and EPROMs, including those in a 24-pin package.

**operation**

FUNCTION (PINS)	MODE								
	Read	Output Disable			Power Down	Start Programming	Inhibit Programming		
PD/PGM (22)	V <sub>IL</sub>	V <sub>IH</sub>	X	X	V <sub>IH</sub>	Pulsed V <sub>IH</sub> to V <sub>IL</sub>	V <sub>IH</sub>	X	X
$\overline{\text{CS}}1$ (21)	V <sub>IL</sub>	X	V <sub>IH</sub>	X	X	V <sub>IL</sub>	X	V <sub>IH</sub>	X
$\overline{\text{CS}}2$ (27)	V <sub>IL</sub>	X	X	V <sub>IH</sub>	X	V <sub>IL</sub>	X	X	V <sub>IH</sub>
V <sub>PP</sub> (1)	+5 V	+5 V			+5 V	+25 V	+25 V		
V <sub>CC</sub> * (26/28)	+5 V	+5 V			+5 V	+5 V	+5 V		
Q (11 to 13, 15 to 19)	Q	HI-Z			HI-Z	D	HI-Z		

X - Don't care.

\* Do not use the internal jumper of 26-28 to conduct PC board currents.

**read/output disable**

When the outputs of two or more TMS 2564's are paralled on the same bus, the output of any particular device in the circuit can be read with no interference from the competing outputs of the other devices. To read the output of the TMS 2564, the low-level signal is applied to the PD/PGM and  $\overline{\text{CS}}$  pins. All other devices in the circuit should have their outputs disabled by applying a high-level signal to one of these pins. Output data is accessed at pins Q1 to Q8. Data can be accessed in 450 ns =  $t_a(A)$ .

**power down**

Active power dissipation can be cut by over 80 percent by applying a high TTL signal to the PD/PGM pin. In this mode all outputs are in a high-impedance state.

**erasure**

Before programming, the TMS 2564 is erased by exposing the chip through the transparent lid to high intensity ultraviolet (wavelength 2537 angstroms). The recommended minimum exposure dose (= UV intensity X exposure time) is fifteen watt-seconds per square centimeter. A typical 12 milliwatt per square centimeter, filterless UV lamp will erase the device in about 21 minutes. The lamp should be located about 2.5 centimeters above the chip during erasure. After erasure, all bits are in the high state.

**start programming**

After erasure (all bits in logic high state), logic "0's" are programmed into the desired locations. A low can be erased only by ultraviolet light. The programming mode is achieved when V<sub>pp</sub> is 25 V. Data is presented in parallel (8 bits) on pins Q1 to Q8. Once addresses and data are stable, a 50 millisecond low TTL pulse should be applied to the PGM pin at each address location to be programmed. Maximum pulse width is 55 milliseconds. Locations can be programmed in any order. More than one TMS 2564 can be programmed when the devices are connected in parallel. During programming both chip select signals should be held low unless program inhibit is desired.

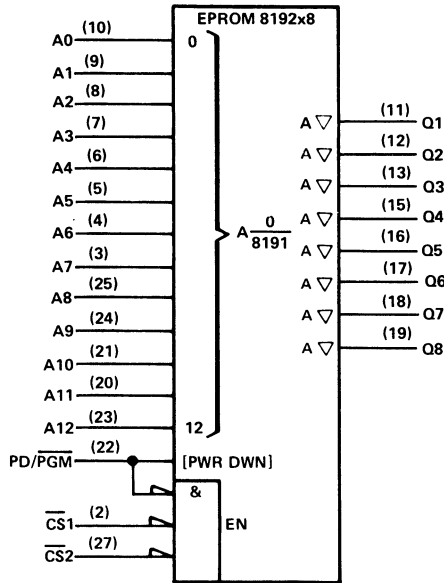
# TMS 2564-45 JL

## 65,536-BIT ERASABLE PROGRAMMABLE READ-ONLY MEMORY

### inhibit programming

When two or more TMS 2564's are connected in parallel, data can be programmed into all devices or only chosen devices. TMS 2564's not intended to be programmed should have a high level applied to PD/PGM or  $\overline{CS1}$  or  $\overline{CS2}$ .

### logic symbol†



† This symbol is in accordance with IEEE Std 91/ANSI Y32.14 and recent decisions by IEEE and IEC. See explanation on page 289.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)\*

Supply voltage, $V_{CC}$ (see Note 1)	.....	-0.3 to 6 V
Supply voltage, $V_{PP}$ (see Note 1)	.....	-0.3 to 28 V
All input voltages (see Note 1)	.....	-0.3 to 6 V
Output voltage (operating with respect to $V_{SS}$ )	.....	-0.3 to 6 V
Operating free-air temperature range	.....	0°C to 70°C
Storage temperature range	.....	-55°C to 125°C

NOTE 1: Under absolute maximum ratings, voltage values are with respect to the most-negative supply voltage,  $V_{SS}$  (substrate).

\* Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the "Recommended Operating Conditions" section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# TMS 2564-45 JL

## 65,536-BIT ERASABLE PROGRAMMABLE READ-ONLY MEMORY

### recommended operating conditions

PARAMETER	MIN	NOM	MAX	UNIT
Supply voltage, $V_{CC}$ (see Note 2)	4.75	5	5.25	V
Supply voltage, $V_{PP}$ (see Note 3)	$V_{CC}$			V
Supply voltage, $V_{SS}$	0			V
High-level input voltage, $V_{IH}$	2	$V_{CC}+1$		V
Low-level input voltage, $V_{IL}$	-0.1 <sup>†</sup>	0.8		V
Read cycle time, $t_{c(rd)}$	450			ns
Operating free-air temperature, $T_A$	0		70	°C

NOTES: 2.  $V_{CC}$  must be applied before or at the same time as  $V_{PP}$  and removed after or at the same time as  $V_{PP}$ . The device must not be inserted into or removed from the board when  $V_{PP}$  or  $V_{CC}$  is applied so that the device is not damaged.

3.  $V_{PP}$  can be connected to  $V_{CC}$  directly (except in the program mode).  $V_{CC}$  supply current in this case would be  $I_{CC} + I_{pp}$ . During programming,  $V_{PP}$  must be maintained at 25 V ( $\pm 1V$ ).

<sup>†</sup> The algebraic convention, where the more negative limit is designated as minimum, is used in this data sheet for logic voltage levels and time intervals.

### electrical characteristics over full ranges of recommended operating conditions

PARAMETER	TEST CONDITIONS	TMS 2564		UNIT
		MIN	TYP <sup>†</sup> MAX	
$V_{OH}$ High-level output voltage*	$I_{OH} = -400 \mu A$	2.4		V
$V_{OL}$ Low-level output voltage*	$I_{OL} = 2.1 \text{ mA}$	0.45		V
$I_I$ Input current (leakage)	$V_I = 5.25 \text{ V}$	10		$\mu A$
$I_O$ Output current (leakage)	$V_O = 5.25 \text{ V}$	10		$\mu A$
$I_{pp1}$ $V_{PP}$ supply current	$V_{PP} = 5.25 \text{ V}$ $PD/\overline{PGM} = V_{IL}$	18		mA
$I_{pp2}$ $V_{PP}$ supply current (during program pulse)	$PD/\overline{PGM} = V_{IL}$	30		mA
$I_{CC1}$ $V_{CC}$ supply current (standby)	$PD/\overline{PGM} = V_{IH}$	15	30	mA
$I_{CC2}$ $V_{CC}$ supply current (active)	$PD/\overline{PGM} = V_{IL}$	80	160	mA

<sup>†</sup> Typical values are at  $T_A = 25^\circ C$  and nominal voltages.

\* AC and DC tests are made at 10% and 90% points using a 50% pattern.

### capacitance over recommended supply voltage and operating free-air temperature range $f = 1 \text{ MHz}^*$

PARAMETER	TEST CONDITIONS	TYP <sup>†</sup>	MAX	UNIT
$C_i$ Input capacitance	$V_I = 0 \text{ V}$ , $f = 1 \text{ MHz}$	4	6	pF
$C_o$ Output capacitance	$V_O = 0 \text{ V}$ , $f = 1 \text{ MHz}$	8	12	pF

<sup>†</sup> All typical values are  $T_A = 25^\circ C$  and nominal voltage.

\* This parameter is tested on sample basis only.

switching characteristics over full ranges of recommended operating conditions (see note 4)

PARAMETER	TEST CONDITIONS (SEE NOTES 4 AND 5)	MIN	TYP <sup>†</sup>	MAX	UNIT
$t_{a(A)}$ Access time from address	$C_L = 100 \text{ pF}$ , 1 Series 74 TTL load, $t_r \leq 20 \text{ ns}$ , $t_f \leq 20 \text{ ns}$ See Figure 1	280	450		ns
$t_{a(S)}$ Access time from $\overline{CS1}$ and $\overline{CS2}$ (whichever occurs last)				120	ns
$t_{a(PR)}$ Access time from PD/ $\overline{PGM}$		280	450	ns	
$t_{v(A)}$ Output data valid after address change		0		ns	
$t_{dis(S)}$ Output disable time from chip select during read only (whichever occurs last) <sup>‡</sup>		0	100	ns	
$t_{dis(PR)}$ Output disable time from PD/ $\overline{PGM}$ during standby <sup>‡</sup>		0	100	ns	

<sup>†</sup> All typical values are at  $T_A = 25^\circ\text{C}$  and nominal voltages.

<sup>‡</sup> Value calculated from 0.5 volt delta to measured output level.

recommended timing requirements for programming  $T_A = 25^\circ\text{C}$  (see note 4)

PARAMETER	MIN	TYP <sup>†</sup>	MAX	UNIT
$t_{w(PR)}$ Pulse width, program pulse	45	50	55	ms
$t_r(PR)$ Rise time, program pulse	5			ns
$t_f(PR)$ Fall time, program pulse	5			ns
$t_{su(A)}$ Address setup time	2			$\mu\text{s}$
$t_{su(D)}$ Data setup time	2			$\mu\text{s}$
$t_{su(VPP)}$ Setup time from $V_{pp}$	0			ns
$t_h(A)$ Address hold time	2			$\mu\text{s}$
$t_h(D)$ Data hold time	2			$\mu\text{s}$
$t_h(PR)$ Program pulse hold time	0			ns
$t_h(VPP)$ $V_{pp}$ hold time	0			ns

<sup>†</sup> Typical values are at nominal voltages.

NOTES: 4. For all switching characteristics and timing measurements, input pulse levels are 0.65 V to 2.2 V and  $V_{pp} = 25 \text{ V} \pm 1 \text{ V}$  during programming. AC and DC timing measurements are made at 90% points using a 50% pattern.

5. Common test conditions apply for  $t_{dis}$  except during programming. For  $t_{a(A)}$ ,  $t_{a(S)}$ , and  $t_{dis}$ ,  $\overline{PD}/\overline{PGM} = V_{IL}$ .

## PARAMETER MEASUREMENT INFORMATION

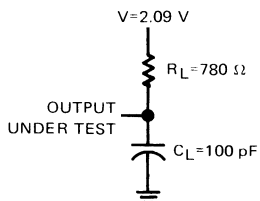
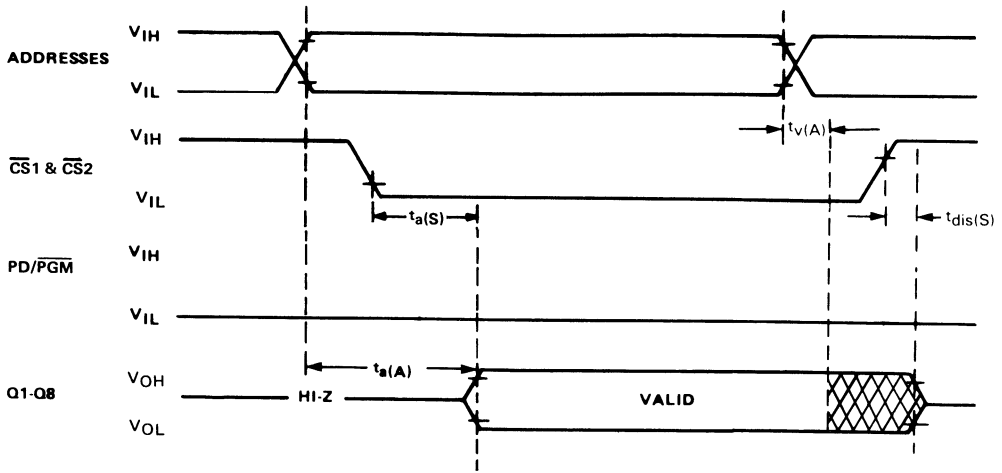


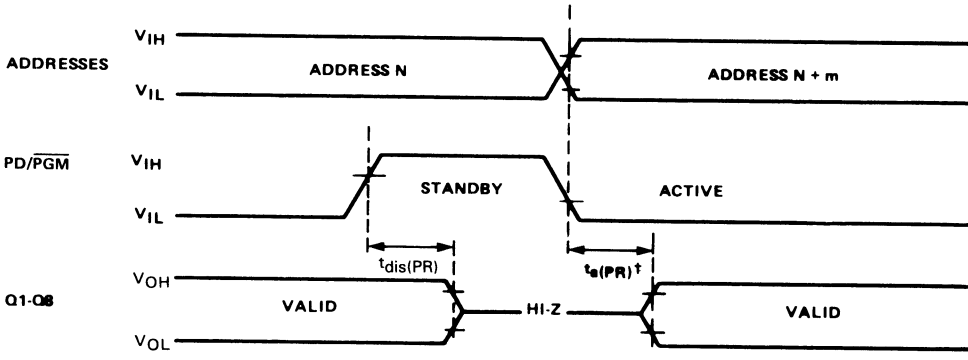
FIGURE 1 – TYPICAL OUTPUT LOAD CIRCUIT

**read cycle timing**



5

**standby mode**

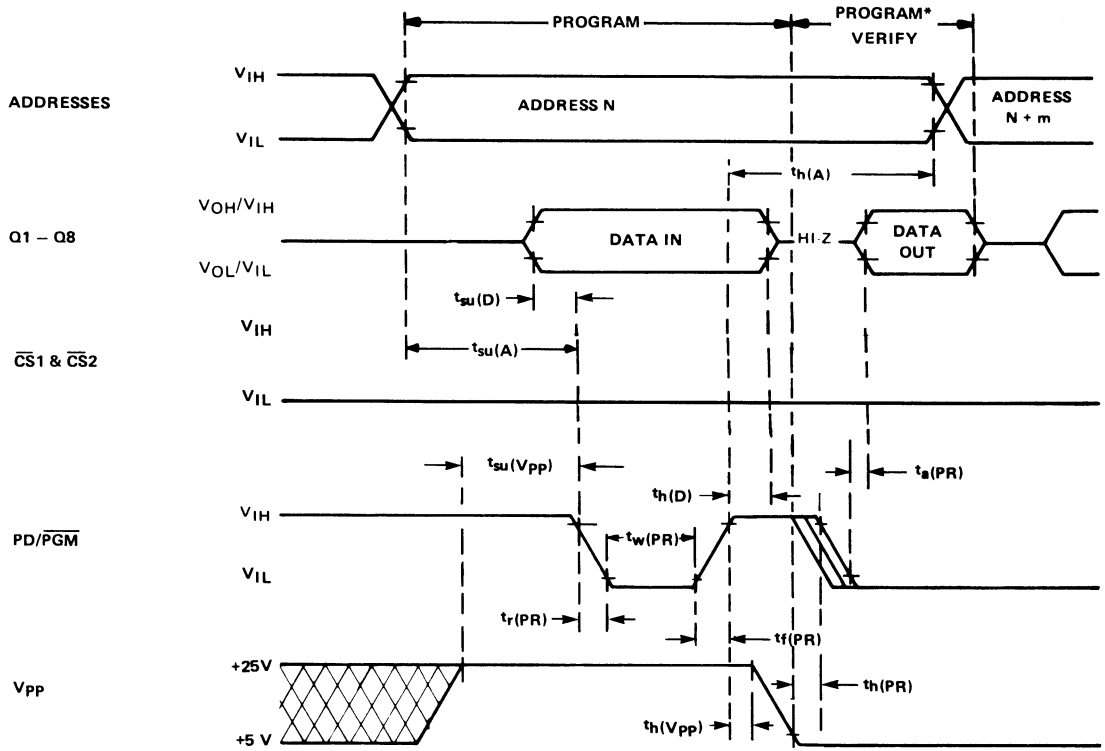


<sup>†</sup>  $t_{a(PR)}$  referenced to  $\overline{PD/PGM}$  or the address, whichever occurs last.  
 $\overline{CS1}$  and  $\overline{CS2}$  in Don't Care State in Standby Mode.

# TMS 2564-45 JL

## 65,536-BIT ERASABLE PROGRAMMABLE READ-ONLY MEMORY

### program cycle timing

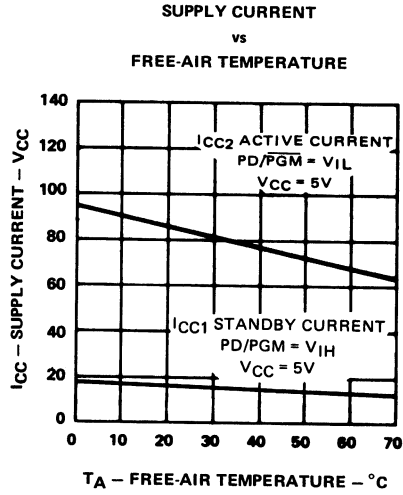


\* Equivalent to read mode.

# TMS 2564-45 JL

## 65,536-BIT ERASABLE PROGRAMMABLE READ-ONLY MEMORY

typical device characteristics (read mode)



5

